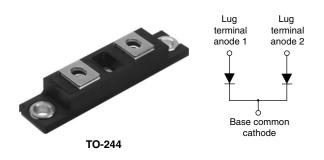
### Vishay High Power Products

## HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 320 A



SHA

PRODUCT SUMMARY				
I <sub>F(AV)</sub>	320 A			
V <sub>R</sub>	400 V			
I <sub>F(DC)</sub> at T <sub>C</sub>	255 A at 85 °C			

### FEATURES

- Very low  $Q_{rr}$  and  $t_{rr}$
- Lead (Pb)-free
- Designed and qualified for industrial level

#### BENEFITS

- · Reduced RFI and EMI
- · Reduced snubbing

#### DESCRIPTION

HEXFRED<sup>®</sup> diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Cathode to anode voltage	V <sub>R</sub>		400	V	
		T <sub>C</sub> = 25 °C	420	A	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 85 °C	255		
		T <sub>C</sub> = 115 °C	160	A	
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	1200		
Non-repetitive avalanche energy	E <sub>AS</sub>	L = 100 $\mu$ H, duty cycle limited by maximum T <sub>J</sub>	1.4	mJ	
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 25 °C 625		W	
		T <sub>C</sub> = 100 °C	250	vv	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 150	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		400	-	-	
		I <sub>F</sub> = 160 A		-	1.10	1.35	v
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 320 A	See fig. 1	-	1.30	1.54	
		I <sub>F</sub> = 160 A, T <sub>J</sub> = 125 °C		-	1.00	1.20	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 125 °C, V <sub>R</sub> = 400 V	See fig. 2	-	0.9	3	mA
Junction capacitance	CT	V <sub>R</sub> = 200 V	See fig. 3	-	370	500	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane - 5.0 -		-	nH		



# HFA320NJ40CPbF

### Vishay High Power Products

### HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 320 A

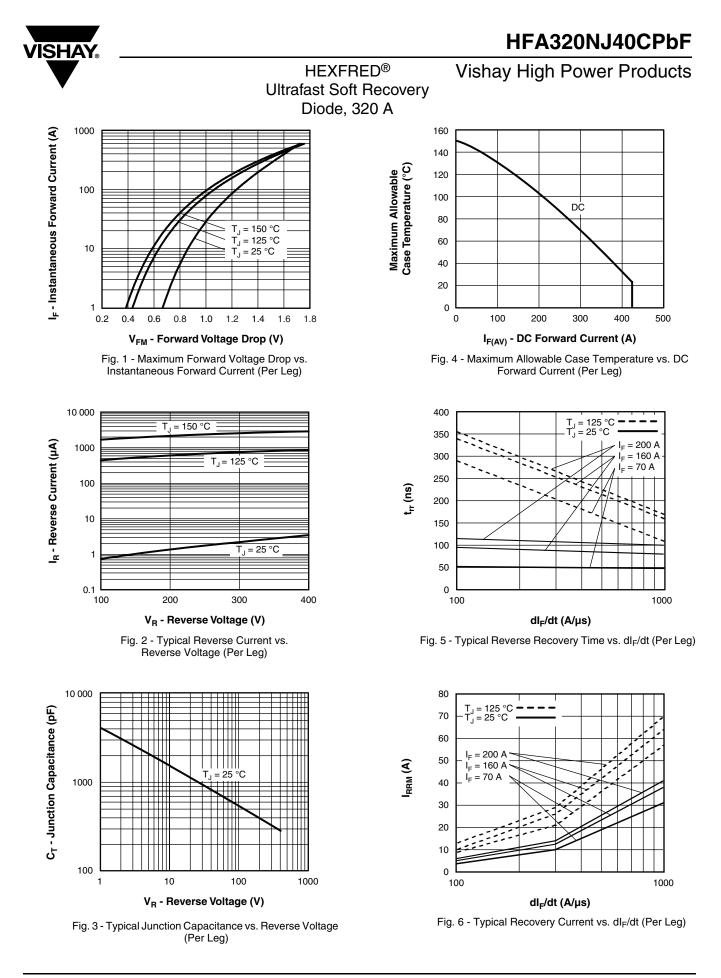
<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 2$	-	45	-		
Reverse recovery time See fig. 5	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	90	140	ns
See lig. 5		T <sub>J</sub> = 125 °C		-	290	440	
Peak recovery current See fig. 6	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	8.7	20	^
		IRRM	T <sub>J</sub> = 125 °C	$I_{\rm F} = 160  {\rm A}$	-	18	30
Reverse recovery charge		T <sub>J</sub> = 25 °C	dI <sub>F</sub> /dt = 200 A/µs V <sub>R</sub> = 200 V	-	420	1100	nC
See fig. 7	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	2600	7000	no
Peak rate of recovery current	eak rate of recovery current	T <sub>J</sub> = 25 °C		-	300	-	A (
See fig. 8	dl <sub>(rec)M</sub> /dt	T <sub>J</sub> = 125 °C		-	280	-	A/μs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature r	ange	T <sub>J</sub> , T <sub>Stg</sub>	- 55	-	150	°C
Thermal resistance, junction to case	per leg	<b>D</b>	-	-	0.19	
mermai resistance, junction to case	per module	R <sub>thJC</sub>	-	-	0.095	°C/W K/W
Typical thermal resistance, case to heatsink	pical thermal resistance, case to heatsink		-	0.10	-	
Weight			-	68	-	g
Weight			-	2.4	-	0Z.
Mounting taxeus	(1)		30 (3.4)	-	40 (4.6)	N
Mounting torque	center hole		12 (1.4)	-	18 (2.1)	N ⋅ m (lbf ⋅ in)
Terminal torque			30 (3.4)	-	40 (4.6)	
Vertical pull 2" lever pull			-	-	80	lle f a line
			-	-	35	lbf ⋅ in

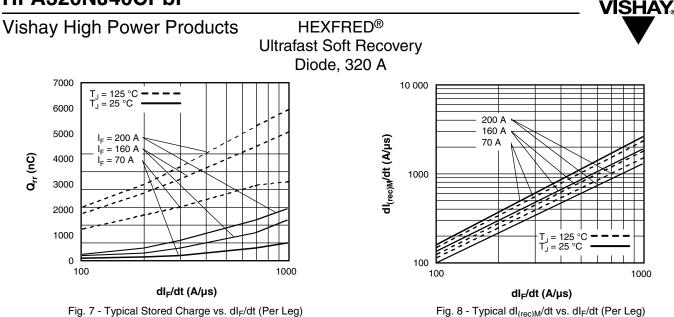
Note

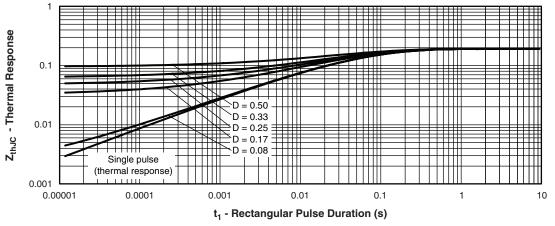
(1) Mounting surface must be smooth, flat, free of burrs or other protrusions. Apply a thin even film or thermal grease to mounting surface. Gradually tighten each mounting bolt in 5 to 10 lbf · in steps until desired or maximum torque limits are reached.





# HFA320NJ40CPbF









## Vishay High Power Products



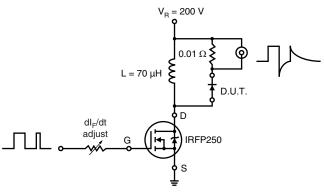
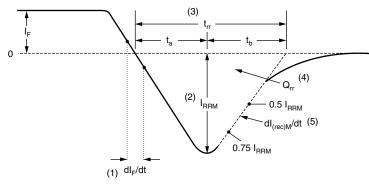


Fig. 10 - Reverse Recovery Parameter Test Circuit



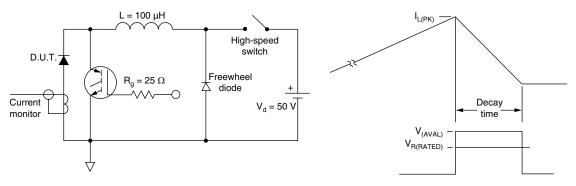
 dl<sub>F</sub>/dt - rate of change of current through zero crossing (4)  ${\rm Q}_{\rm rr}$  - area under curve defined by  ${\rm t}_{\rm rr}$  and  ${\rm I}_{\rm RBM}$ 

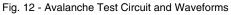
(2)  $I_{\text{RRM}}$  - peak reverse recovery current

(3)  $t_{\rm rr}$  - reverse recovery time measured from zero crossing point of negative going  ${\rm I_F}$  to point where a line passing through 0.75  ${\rm I_{RRM}}$  and 0.50  ${\rm I_{RRM}}$  extrapolated to zero current.



- (5)  $dI_{(rec)M}/dt$  peak rate of change of current during  $t_b$  portion of  $t_{rr}$
- Fig. 11 Reverse Recovery Waveform and Definitions





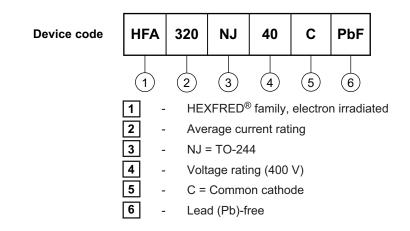
## HFA320NJ40CPbF

_	<b>VISHAY</b>

HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 320 A

### **ORDERING INFORMATION TABLE**

Vishay High Power Products



LINKS TO RELATED DOCUMENTS				
Dimensions	http://www.vishay.com/doc?95021			



Vishay

## Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.